LSF-SMT 5.00/02/135 3.5SN BK TU INK

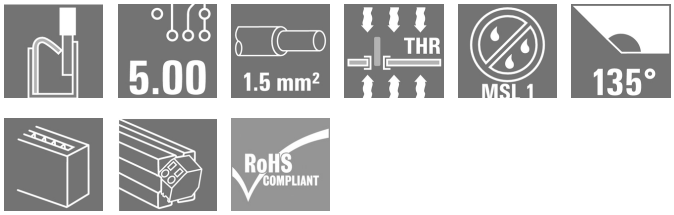
Weidmüller Interface GmbH & Co. KG
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Product image



Similar to illustration



PCB terminal for fully automatic assembly in reflow soldering (SMT), with Push In conductor connection system. Conductor inserted and slider operated in same direction (TOP). Packed in box or as tape on reel. Pin lengths optimised at 1.5 mm or 3.5 mm.

General ordering data

Version	Printed circuit board terminals, 5.00 mm, Number of poles: 2, 135°, Solder pin length (l): 3.5 mm, black, PUSH IN with actuator, Clamping range, max. : 1.5 mm², Tube
Order No.	1062740000
Type	LSF-SMT 5.00/02/135 3.5SN BK TU INK
GTIN (EAN)	4032248813728
Qty.	60 pc(s).
Product data	IEC: 500 V / 17.5 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 28 - AWG 14
Packaging	Tube

Creation date December 4, 2023 12:46:26 PM CET

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Technical data

Dimensions and weights

Depth	12.7 mm	Depth (inches)	0.5 inch
Height	12 mm	Height (inches)	0.472 inch
Height of lowest version	12.9 mm	Width	9.2 mm
Width (inches)	0.362 inch	Net weight	2.22 g

Temperatures

Continuous operating temp., max.	120 °C

System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN with actuator
Mounting onto the PCB	THT/THR solder connection	Conductor outlet direction	135°
Pitch in mm (P)	5 mm	Pitch in inches (P)	0.197 inch
Number of poles	2	Pin series quantity	1
Fitted by customer	No	Solder pin length (l)	3.5 mm
Solder pin length tolerance	+0.1 / -0.3 mm	Solder pin dimensions	0.35 x 0.8 mm
Solder pin dimensions = d tolerance	0 / -0.1 mm	Solder eyelet hole diameter (D)	1.1 mm
Solder eyelet hole diameter tolerance (D)	+ 0,1 mm	Number of solder pins per pole	2
Stripping length	8 mm	L1 in mm	5 mm
L1 in inches	0.197 inch	Touch-safe protection acc. to DIN VDE 0470	IP 20
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Protection degree	IP20
Volume resistance	1.60 mΩ		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Layer structure of solder connection	4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm²
Clamping range, max.	1.5 mm²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm²
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm²
Flexible, max. H05(07) V-K	1.5 mm²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm²

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Technical data

w. wire end ferrule, DIN 46228 pt 1, min.	0.25 mm²		
w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm²		
Clampable conductor	Cross-section for conductor connection	Type	fine-wired
		nominal	0.25 mm²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0,25/12 HBL
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.34 mm²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0,34/12 TK
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.5 mm²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0,5/14 OR
	Cross-section for conductor connection	Type	fine-wired
		nominal	0.75 mm²
	wire end ferrule	Stripping length	nominal 10 mm
		Recommended wire-end ferrule	H0,75/14T HBL
Reference text	Length of ferrules is to be chosen depending on the product and the rated voltage., The outside diameter of the plastic collar should not be larger than the pitch (P)		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	17.5 A
Rated current, max. number of poles (Tu=20°C)	17.5 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	15 A	Rated voltage for surge voltage class / pollution degree II/2	500 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Short-time withstand current resistance	3 x 1s with 80 A

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14

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Technical data

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	12 A	Rated current (Use group D / UL 1059)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Tube	VPE length	555 mm
VPE width	22 mm	VPE height	17 mm
Surface resistance	Rs = 10^9 - 10^{12} Ω		

Type tests

Test: Durability of markings	Test	mark of origin, type identification, pitch, approval marking UL, durability	
	Evaluation	available	
Test: Clampable cross section	Standard	DIN EN 60999-1 section 7 and 9.1 / 12.00, DIN EN 60947-1 section 8.2.4.5.1 / 12.02	
	Conductor type	Type of conductor and conductor cross-section	solid 0.14 mm²
		Type of conductor and conductor cross-section	stranded 0.14 mm²
		Type of conductor and conductor cross-section	solid 1.5 mm²
		Type of conductor and conductor cross-section	stranded 1.5 mm²
		Type of conductor and conductor cross-section	AWG 24/1
		Type of conductor and conductor cross-section	AWG 26/19
		Type of conductor and conductor cross-section	AWG 16/1
		Type of conductor and conductor cross-section	AWG 16/19
	Evaluation	passed	

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Test for damage to and accidental loosening of conductors	Standard	DIN EN 60999-1 section 9.4 / 12.00	
	Requirement	0.2 kg	
	Conductor type	Type of conductor and conductor cross-section	AWG 24/1
		Type of conductor and conductor cross-section	AWG 24/19
	Requirement	0.3 kg	
	Conductor type	Type of conductor and conductor cross-section	stranded 0.25 mm²
		Type of conductor and conductor cross-section	solid 0.5 mm²
	Evaluation	passed	
	Requirement	0.4 kg	
	Conductor type	Type of conductor and conductor cross-section	solid 1.5 mm²
		Type of conductor and conductor cross-section	stranded 1.5 mm²
		Type of conductor and conductor cross-section	AWG 16/1
		Type of conductor and conductor cross-section	AWG 16/19
	Evaluation	passed	
Pull-out test	Standard	DIN EN 60999-1 section 9.5 / 12.00	
	Requirement	≥10 N	
	Conductor type	Type of conductor and conductor cross-section	AWG 24/1
		Type of conductor and conductor cross-section	AWG 24/19
	Evaluation	passed	
	Requirement	≥20 N	
	Conductor type	Type of conductor and conductor cross-section	stranded 0.25 mm²
		Type of conductor and conductor cross-section	H05V-K0.5
	Evaluation	passed	
	Requirement	≥40 N	
	Conductor type	Type of conductor and conductor cross-section	H07V-U1.5
		Type of conductor and conductor cross-section	H07V-K1.5
		Type of conductor and conductor cross-section	AWG 16/1
		Type of conductor and conductor cross-section	AWG 16/19
	Evaluation	passed	

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Technical data

Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ETIM 8.0	EC002643	ETIM 9.0	EC002643
ECLASS 9.0	27-44-04-01	ECLASS 9.1	27-44-04-01
ECLASS 10.0	27-44-04-01	ECLASS 11.0	27-46-01-01
ECLASS 12.0	27-46-01-01	ECLASS 13.0	27460101

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Additional push button colours on request • Operating force of slider max. 40 N • Rated current related to rated cross-section & min. No. of poles. • Wire end ferrule with plastic collar to DIN 46228/4 • Wire end ferrule without plastic collar to DIN 46228/1 • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool recommended. • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals	c UL us
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (cURus)	E60693

Downloads

Product Change Notification	PCN_2017_209_PL33x_feste_Kodierung_BLx_750_762_DE PCN_2017_209_PL33x_fixed_coding_BLx_750_762_EN Capacity expansion of LSF-SMT stamping tools Kapazitätserweiterung der Stanzwerkzeuge LSF-SMT
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN FL DRIVES DE
White paper surface mount technology	Download Whitepaper

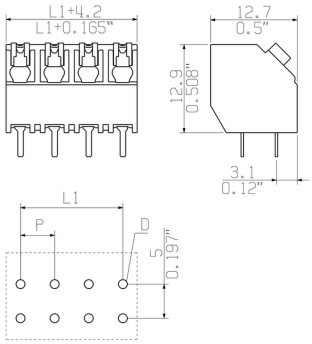
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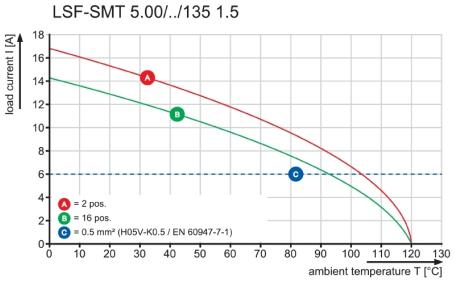
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Drawings

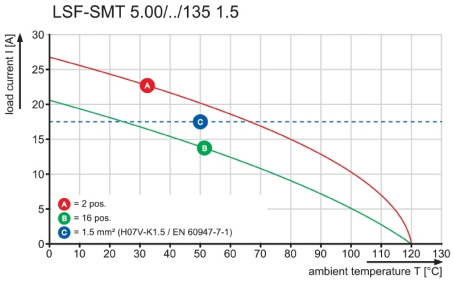
Dimensional drawing



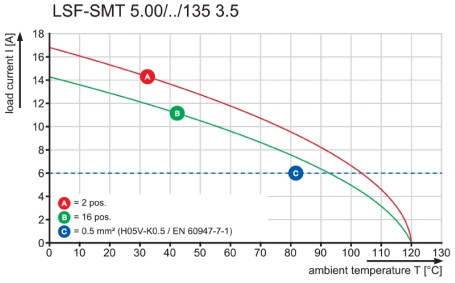
Graph



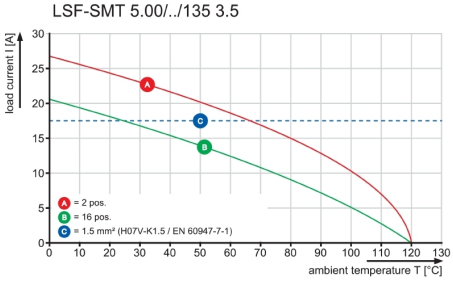
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Graph



Graph

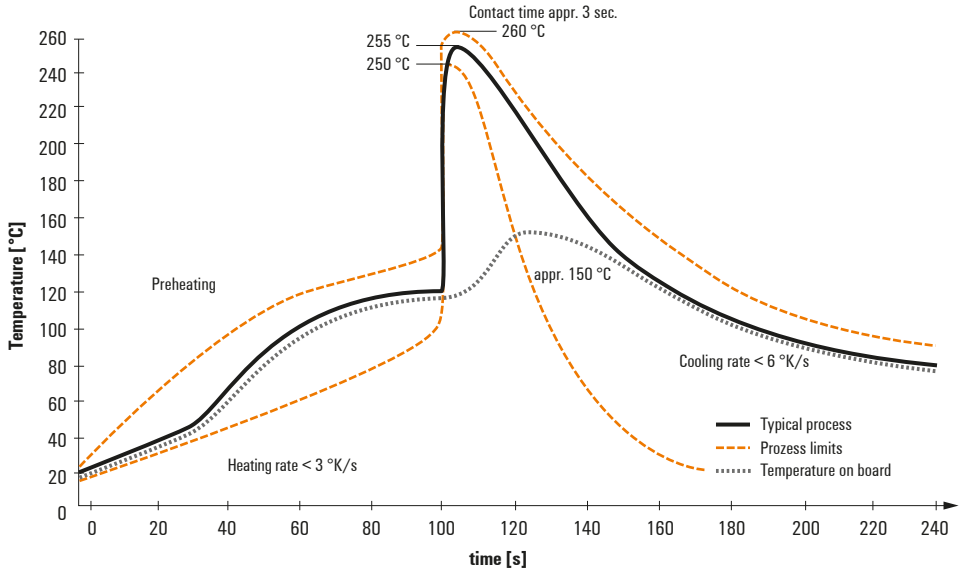


Wave Solder Profile

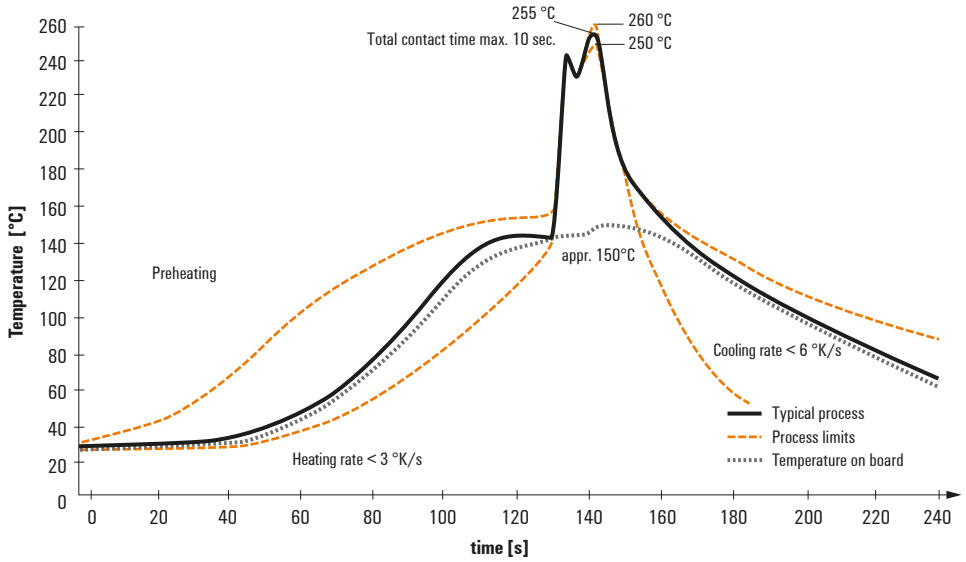
Recommended wave solderding profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

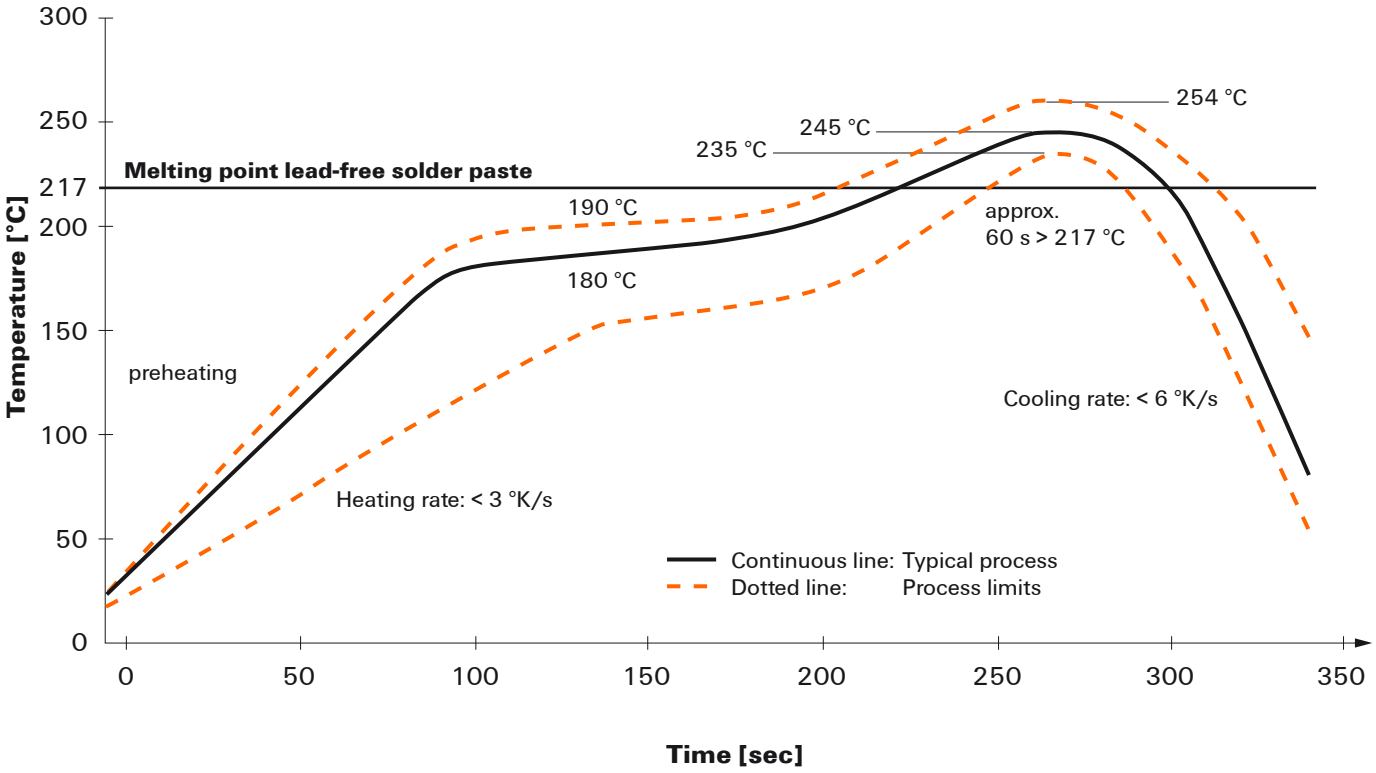
The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Reflow Solder Profile

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:
- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically ≤ +3K/s. In parallel the solder paste is ‚activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at ≥ -6K/s solder is cured. Board and components cool down while avoiding cold cracks.

We reserve the right to make technical changes.